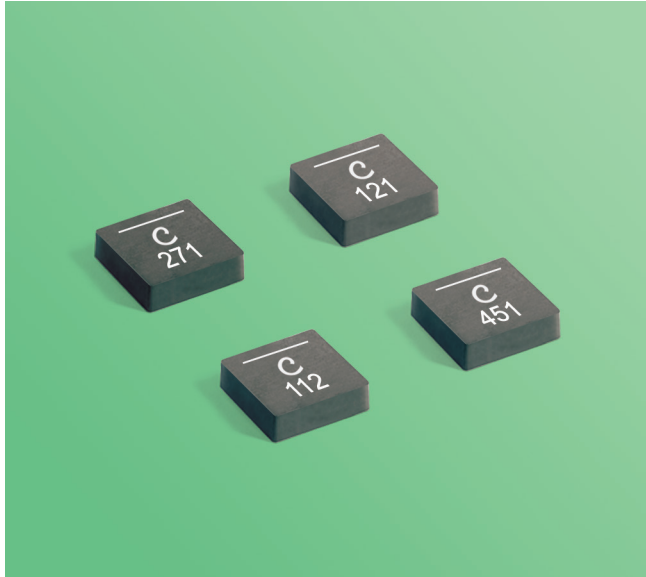


High Reliability Power Inductors ML483PYA



- High temperature materials allow operation in ambient temperatures up to 155°C
- Passes vibration testing to 80 G and shock testing to 1000 G
- Exceptionally low DCR – 1.6 mOhm
- Soft saturation makes them ideal for VRM/VRD applications.

Terminations Tin-silver (96.5/3.5) over copper.

Core material Composite

Weight 0.36 – 0.49 g

Ambient temperature –55°C to +105°C with Irms current

Maximum part temperature +155°C (ambient + temp rise).

Storage temperature Component: –55°C to +155°C.

Tape and reel packaging: –55°C to +80°C

Resistance to soldering heat Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

Moisture Sensitivity Level (MSL) 1 (unlimited floor life at <30°C / 85% relative humidity)

Enhanced crush-resistant packaging 500 per 7" reel
Plastic tape: 12 mm wide, 0.3 mm thick, 8 mm pocket spacing, 2.16 mm pocket depth

Part number ¹	Inductance ² ±20% (µH)	DCR (mOhms) ³		SRF (MHz) ⁴		Isat (A) ⁵	Irms (A) ⁶	
		typ	max	min	typ		20°C rise	40°C rise
ML483PYA121MLZ	0.12	1.60	1.85	132	165	45	15.8	20.3
ML483PYA161MLZ	0.16	2.35	2.70	121	152	41	15.0	19.5
ML483PYA271MLZ	0.27	3.45	3.85	77	97	29.5	14.3	18.8
ML483PYA451MLZ	0.45	4.60	5.05	58	73	24.5	12.8	16.5
ML483PYA601MLZ	0.60	6.45	7.10	52	66	20.5	11.3	13.9
ML483PYA901MLZ	0.90	10.63	11.10	44	56	19.1	8.6	11.4
ML483PYA112MLZ	1.1	12.60	13.10	40	50	17.1	7.5	9.0

1. When ordering, please specify **screening** code:

ML483PYA112MLZ

Screening: Z = Unscreened
Y = Unscreened (SLDC Option A)
W = Unscreened (SLDC Option B)
H = Group A screening per Coilcraft CP-SA-10001
G = Coilcraft CP-SA-10001 Group A (SLDC Option A)
D = Coilcraft CP-SA-10001 Group A (SLDC Option B)
All screening performed to the document's latest revision

- Inductance tested at 100 kHz, 0.1 Vrms, 0 Adc.
- DCR measured on a micro-ohmmeter.
- SRF measured using an Agilent/HP 4395A or equivalent.
- DC current at 25°C that causes a 30% (typ) inductance drop from its value without current.
- DC current at 25°C that causes the specified inductance drop from its value without current.
- Current that causes the specified temperature rise from 25°C ambient. This information is for reference only and does not represent absolute maximum ratings.
- Electrical specifications at 25°C.

Refer to Doc 362 "Soldering Surface Mount Components" before soldering.

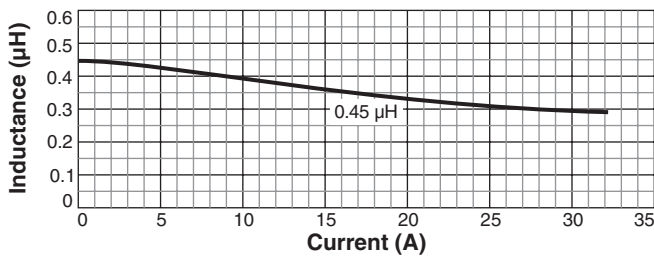
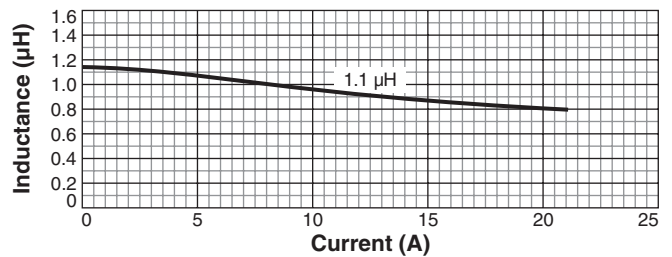
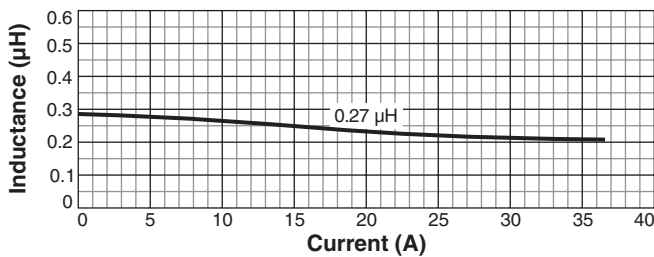
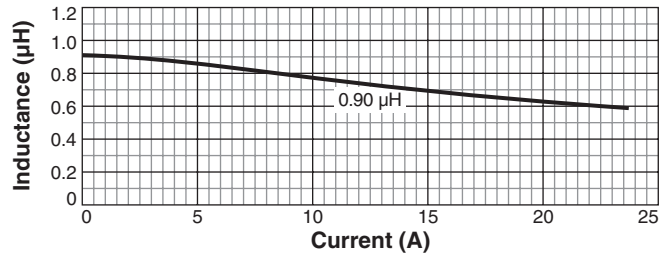
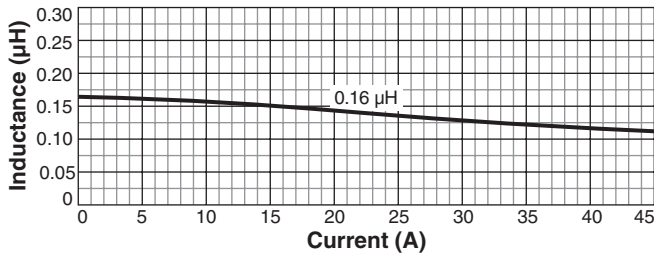
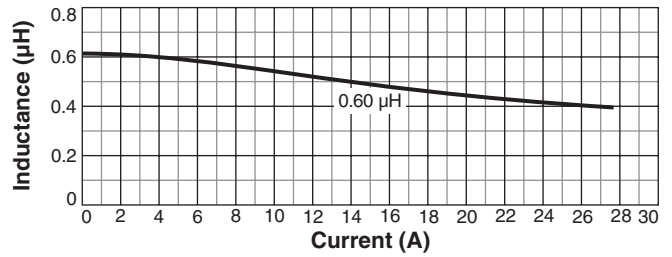
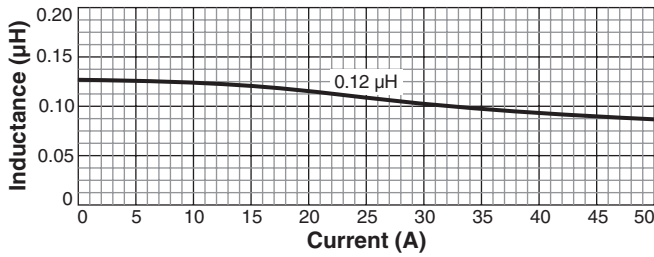
Irms Testing

Irms testing was performed on a 0.060" thick pcb with 4 oz. copper traces optimized to minimize additional temperature rise.

Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components. Therefore temperature rise should be verified in application conditions.

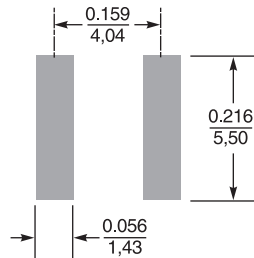
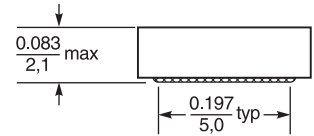
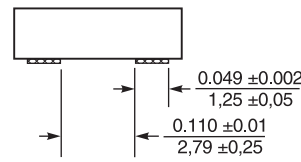
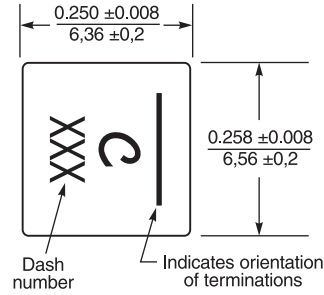
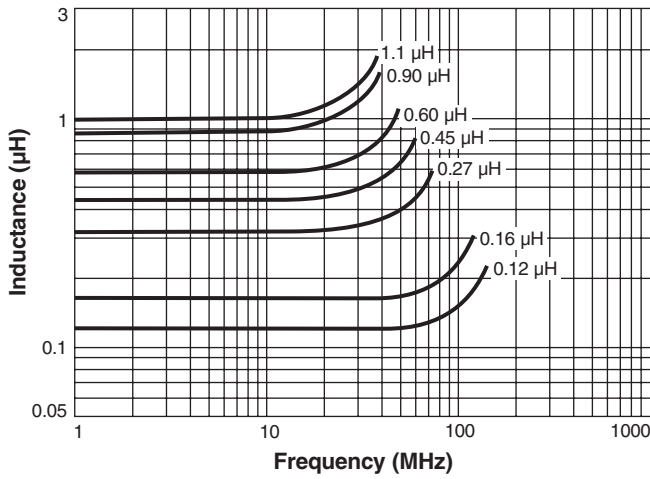
ML483PYA Series

L vs Current



ML483PYA Series

L vs Frequency



Suggested Land Pattern

Dimensions are in $\frac{\text{inches}}{\text{mm}}$